TOSHIBA Photocoupler GaAłAs Ired & Photo-IC

# **TLP251**

Inverter For Air Conditionor Induction Heating Transistor Inverter Power MOS FET Gate Drive IGBT Gate Drive

The TOSHIBA TLP251 consists of a GaAtAs light emitting diode and a integrated photodetector.

This unit is 8-lead DIP package.

TLP251 is suitable for gate driving circuit of IGBT or power MOS FET. Especially TLP251 is capable of "direct" gate drive of lower power IGBTs. (~15A)

- Input threshold current: IF=5mA(max.)
- Supply current (ICC): 11mA(max.)
- Supply voltage (V<sub>CC</sub>): 10–35V
- Output current (I<sub>O</sub>): ±0.4A(max.)
- Switching time (t<sub>pLH</sub> / t<sub>pHL</sub>): 1µs(max.)
- Isolation voltage: 2500Vrms(min.)
- UL recognized: UL1577, file no.E67349

#### Schematic



A  $0.1\mu$ F bypass capcitor must be connected between pin 8 and 5(see Note 5).

#### **Truth Table**

		Tr1	Tr2		
Input	On	On	Off		
LED	Off	Off	On		



Weight: 0.54g

### Pin Configuration (top view)



#### Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit
	Forward current	١ <sub>F</sub>	20	mA	
	Forward current derating (Ta ≥ 70°C)		ΔI <sub>F</sub> / ΔTa	- 0.36	mA / °C
LED	Peak transient forward current	(Note 1)	IFPT	1	A
	Reverse voltage		V <sub>R</sub>	5	V
	Junction temperature		Тj	125	°C
	"H" peak output current (P <sub>W</sub> ≤ 2.0μs, f ≤ 15kHz)	(Note 2)	Іорн	- 0.4	A
	"L" peak output current (P <sub>W</sub> ≤ 2.0μs, f ≤ 15kHz)	(Note 2)	IOPL	0.4	A
Detector	Output voltage $(Ta \le 70^{\circ})$ $(Ta = 85^{\circ})$		Vo	35 24	V
	Supply voltage	(Ta ≤ 70°C) (Ta = 85°C)	V <sub>CC</sub>	35 24	V
	Output voltage derating (Ta ≥ 70°C)		ΔV <sub>O</sub> /ΔTa	- 0.73	V / °C
	Supply voltage derating (Ta ≥ 70°C)		ΔV <sub>CC</sub> / ΔTa	- 0.73	V / °C
	Junction temperature		Тj	125	°C
Opera	ating frequency	f	25	kHz	
Oper	ating temperature range	T <sub>opr</sub>	-20~85	°C	
Stora	ge temperature range	T <sub>stg</sub>	-55~125	°C	
Lead	soldering temperature(10s)	T <sub>sol</sub>	260	°C	
Isolation voltage (AC, 1min., R.H.≤ 60%) (Note 4)			BVS	2500	Vrms

(Note 1) Pulse width  $P_W \le 1\mu s$ , 300pps

(Note 2) Expornential waveform

- (Note 3) Expornential waveform,  $I_{OPH} \le -0.25A (\le 2.0\mu s)$ ,  $I_{OPL} \le +0.25A (\le 2.0\mu s)$
- (Note 4) Device considerd a two terminal device: Pins 1, 2, 3 and 4 shorted together, and pins 5, 6,7 and 8 shorted together.
- (Note 5) A ceramic capacitor(0.1µF)should be connected from pin 8 to pin 5 to stabilize the operation of the high gain linear ampifier. Failure to provide the bypassing may impair the swiching property. The total lead length between capacitor and coupler should not exceed 1cm.

### **Recommended Operating Conditions**

Characteristic	Symbol	Min.	Тур.	Max.		Unit
Input current, on	I <sub>F(ON)</sub>	7	8	10		mA
Input voltage, off	V <sub>F(OFF)</sub>	0	_	0.8		V
Supply voltage	V <sub>CC</sub>	10		30	20	V
Peak output current	I <sub>OPH</sub> / I <sub>OPL</sub>			±0.1		А
Operating temperature	T <sub>opr</sub>	-20	25	70	85	°C

### Electrical Characteristics (Ta = -20~70°C, unless otherwise specified)

Characteristic		Symbol	Test Cir– cuit	Test Condition	Min.	Тур.*	Max.	Unit	
Input forward voltage		VF		I <sub>F</sub> = 10 mA , Ta = 25°C	_	1.6	1.8	V	
Temperature coefficient of forward voltage		ΔV <sub>F</sub> / ΔTa	_	I <sub>F</sub> = 10 mA	_	-2.0	_	mV / °C	
Input reverse current		I <sub>R</sub>	_	V <sub>R</sub> = 5V, Ta = 25°C	-	-	10	μA	
Input capacitance		CT		V = 0 , f = 1MHz , Ta = 25°C	-	45	250	pF	
Quita et aureant	"H" level	I <sub>OPH</sub>	3	I <sub>F</sub> = 10mA V <sub>CC</sub> =30V V <sub>8-6</sub> = 4V	-0.1	-0.25	_	A	
	"L" level	I <sub>OPL</sub>	2	(*1) I <sub>F</sub> =0 V <sub>6-5</sub> = 2.5V	0.1	0.2	_		
Output voltage	"H" level	V <sub>OH</sub>	4	$V_{CC1}$ = +15V, $V_{EE1}$ = -15V R <sub>L</sub> = 200Ω, I <sub>F</sub> = 5mA	11	13.2	_	V	
	"L" level	V <sub>OL</sub>	5	$V_{CC1}$ = +15V, $V_{EE1}$ = -15V R <sub>L</sub> = 200Ω, $V_F$ = 0.8V	_	-14.5	-12.5		
	"H" level	Іссн	_	V <sub>CC</sub> = 30V, I <sub>F</sub> = 10mA Ta = 25°C	_	7.5	_		
Cumply summert				V <sub>CC</sub> = 30V, I <sub>F</sub> = 10mA		_	11	m۸	
Supply current	"L" level	ICCL	_	V <sub>CC</sub> = 30V, I <sub>F</sub> = 0mA Ta = 25°C	_	8	_		
				V <sub>CC</sub> = 30V, I <sub>F</sub> = 0mA	_	_	11		
Threshould input current	"Output $L \rightarrow H$ "	I <sub>FLH</sub>		$V_{CC1}$ = +15V, $V_{EE1}$ = -15V R <sub>L</sub> = 200Ω, $V_O$ > 0V		1.2	5	mA	
Threshold input voltage	"Output $H \rightarrow L$ "	V <sub>FLH</sub>		$V_{CC1}$ = +15V, $V_{EE1}$ = -15V R <sub>L</sub> = 200Ω, $V_O$ < 0V	0.8			V	
Supply voltage		V <sub>CC</sub>	—		10	—	35	V	
Capacitance (input–output)		Cs	—	Vs = 0 , f = 1MHz Ta = 25°C	_	1.0	2.0	pF	
Resistance (input-output)		R <sub>s</sub>	_	Vs = 500V, Ta = 25°C R.H. ≤ 60%	1×10 <sup>12</sup>	10 <sup>14</sup>		Ω	

\* All typical values are at Ta=25°C (\*1): Duration of I<sub>O</sub> time  $\leq$  50µs

### Switching Characteristics (Ta = $-20 \sim 70^{\circ}$ C, unless otherwise specified)

Characteristic		Symbol	Test Cir– cuit	Test Condition	Min.	Тур.*	Max.	Unit
Propagation	L→H	t <sub>pLH</sub>	6		_	0.25	1.0	
delay time	H→L	t <sub>pHL</sub>		$I_F = 8mA$	_	0.25	1.0	
Output rise time		tr		$R_{L} = 200 \Omega$	_	—	—	μ3
Output fall time		t <sub>f</sub>			_	—	—	
Common mode transient immunity at high level output		C <sub>MH</sub>	7	V <sub>CM</sub> = 600V, I <sub>F</sub> = 8mA, V <sub>CC</sub> = 30V, Ta = 25℃	-5000	_	_	V / µs
Common mode transient immunity at low level output		C <sub>ML</sub>	7	V <sub>CM</sub> = 600V, I <sub>F</sub> = 0mA, V <sub>CC</sub> = 30V, Ta = 25°C	5000	_	_	V / µs

\*All typical values are at Ta=25°C

### Test Circuit 1:

Test Circuit 2: IOPL





### Test Circuit 3: IOPH

Test Circuit 4: V<sub>OH</sub>



### Test Circuit 5: VOL



### Test Circuit 6: t<sub>pLH</sub>, t<sub>pHL</sub>, t<sub>r</sub>, t<sub>f</sub>





### Test Circuit 7: C<sub>MH,</sub> C<sub>ML</sub>



 $C_{ML}$  ( $C_{MH}$ ) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.











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